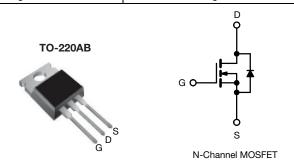


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Vishay Siliconix

### **Power MOSFET**

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	1000			
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = 10 V 11			
Q <sub>g</sub> max. (nC)	38			
Q <sub>gs</sub> (nC)	4.9			
Q <sub>gd</sub> (nC)	22			
Configuration	Single			



#### **FEATURES**

- Dynamic dV/dt rating
- Repetitive avalanche rated
- · Fast switching
- · Ease of paralleling
- Simple drive requirements
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### Note

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details.

#### **DESCRIPTION**

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION		
Package	TO-220AB	
Lead (Pb)-free	IRFBG20PbF	
Lead (Pb)-free	SiHFBG20-E3	
SnPb	IRFBG20	
SIIPD	SiHFBG20	

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>C</sub> = 25 °C, unless otherwi			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V <sub>DS</sub>	1000	.,	
Gate-Source Voltage			V <sub>GS</sub>	± 20	_ V	
Continuous Drain Current	V <sub>GS</sub> at 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$		1.4		
Continuous Drain Current		T <sub>C</sub> = 100 °C	I <sub>D</sub>	0.86	Α	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	5.6	1	
Linear Derating Factor				0.43	W/°C	
Single Pulse Avalanche Energy b			E <sub>AS</sub>	200	mJ	
Repetitive Avalanche Current <sup>a</sup>			I <sub>AR</sub>	1.4	Α	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	5.4	mJ	
Maximum Power Dissipation $T_C = 25  ^{\circ}C$			P <sub>D</sub>	54	W	
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	1.0	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Soldering Recommendations (Peak temperature) d for 10 s				300		
Maunting Tayous	6.22.04	0.00 - 140		10	lbf ⋅ in	
Mounting Torque	6-32 or M3 screw			1.1	N⋅m	

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b.  $V_{DD}=50$  V, starting  $T_J=25$  °C, L=193  $\mu H,$   $R_g=25$   $\Omega,$   $I_{AS}=1.4$  A (see fig. 12). c.  $I_{SD}\leq 1.4$  A,  $dI/dt\leq 60$  A/ $\mu s,$   $V_{DD}\leq 600,$   $T_J\leq 150$  °C. d. 1.6 mm from case.



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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	62		
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>	0.50	=	°C/W	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	2.3		

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static		<u> </u>			I.	•	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> :	= 0 V, I <sub>D</sub> = 250 μA	1000	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, I <sub>D</sub> = 1 mA		-	1.2	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>		V <sub>GS</sub> = ± 20 V	-	-	± 100	nA
Zero Gate Voltage Drain Current		V <sub>DS</sub> =	1000 V, V <sub>GS</sub> = 0 V	-	-	100	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 800 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C		1	-	500	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 0.84 A <sup>b</sup>	-	-	11	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> =	$50 \text{ V}, I_D = 0.84 \text{ A}^{\text{ b}}$	1.0	-	-	S
Dynamic							
Input Capacitance	$C_{iss}$	$V_{GS} = 0 V$ ,		1	500	-	pF
Output Capacitance	$C_{oss}$	]	$V_{DS} = 25 V$ ,		52	-	
Reverse Transfer Capacitance	$C_{rss}$	f = 1	.0 MHz, see fig. 5	1	17	-	
Total Gate Charge	$Q_g$			-	-	38	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$I_D = 1.4 \text{ A}, V_{DS} = 400 \text{ V},$ see fig. 6 and 13 b	-	-	4.9	nC
Gate-Drain Charge	Q <sub>gd</sub>		3	-	-	22	1
Turn-On Delay Time	t <sub>d(on)</sub>			-	9.4	-	
Rise Time	t <sub>r</sub>	V <sub>DD</sub> =	: 500 V, I <sub>D</sub> = 1.4 A,	-	17	-	
Turn-Off Delay Time	t <sub>d(off)</sub>		$R_D = 370 \Omega$ , see fig. 10 b	-	58	-	ns
Fall Time	t <sub>f</sub>			-	31	-	
Internal Drain Inductance	$L_{D}$	Between lead, 6 mm (0.25") from		-	4.5	-	nU
Internal Source Inductance	L <sub>S</sub>	package and die contact	center of	-	7.5	-	nH
Gate Input Resistance	R <sub>g</sub>	f = 1	MHz, open drain	0.6	-	3.4	Ω
Drain-Source Body Diode Characteristic	s						•
Continuous Source-Drain Diode Current	Is	showing the integral reverse		1.4	^		
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	5.6	A	
Body Diode Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C	, I <sub>S</sub> = 1.4 A, V <sub>GS</sub> = 0 V <sup>b</sup>	-	-	1.5	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	- 130 190		190	ns		
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	$J = 25  \text{C}, I_{\text{F}}$	= 1.4 A, dl/dt = 100 A/µs b	-	0.46	0.69	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic tu	ırn-on time is negligible (turn	on is dor	ninated b	y L <sub>S</sub> and	L <sub>D</sub> )

### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq 300~\mu s$ ; duty cycle  $\leq 2~\%$ .



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

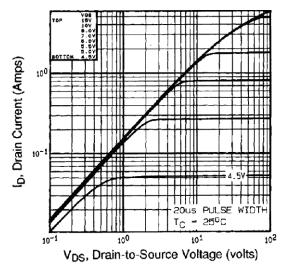


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C

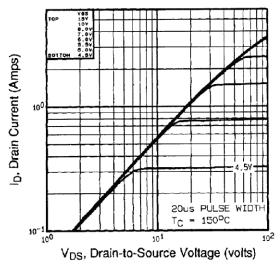


Fig. 2 - Typical Output Characteristics,  $T_C = 150$  °C

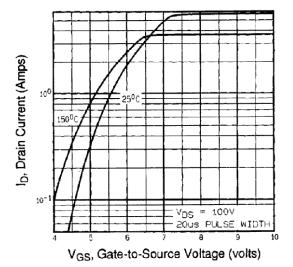


Fig. 3 - Typical Transfer Characteristics

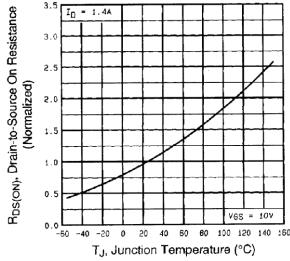


Fig. 4 - Normalized On-Resistance vs. Temperature



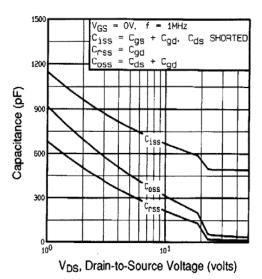


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

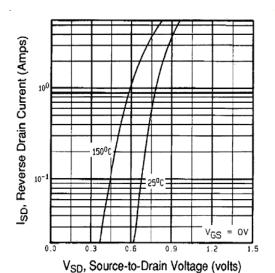


Fig. 7 - Typical Source-Drain Diode Forward Voltage

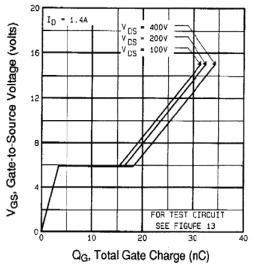


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

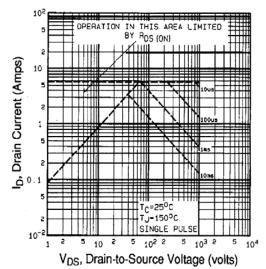


Fig. 8 - Maximum Safe Operating Area



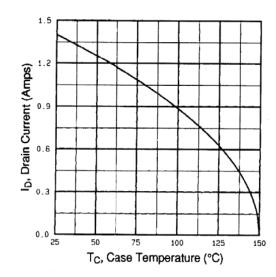


Fig. 9 - Maximum Drain Current vs. Case Temperature

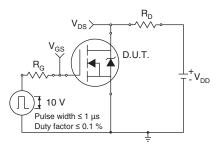


Fig. 10a - Switching Time Test Circuit

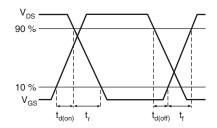


Fig. 10b - Switching Time Waveforms

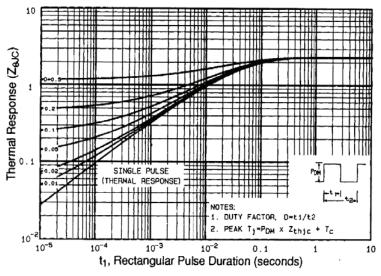


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

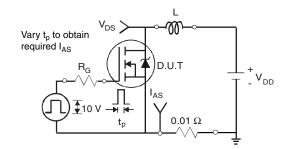


Fig. 12a - Unclamped Inductive Test Circuit

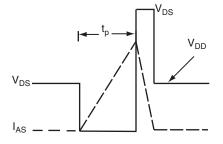


Fig. 12b - Unclamped Inductive Waveforms



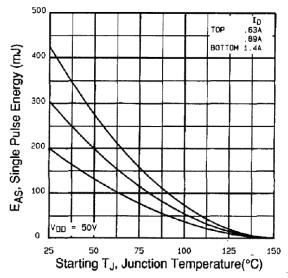


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

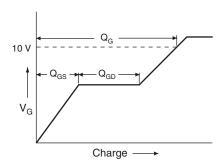


Fig. 13a - Basic Gate Charge Waveform

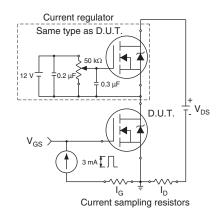
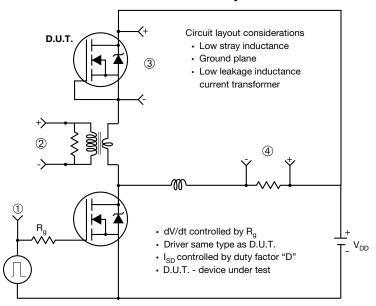


Fig. 13b - Gate Charge Test Circuit



### Peak Diode Recovery dV/dt Test Circuit



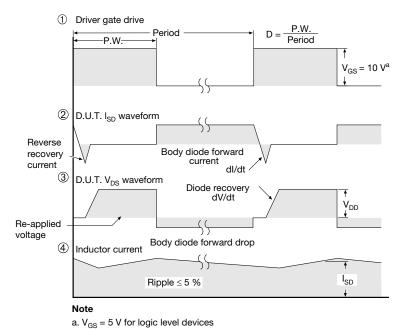


Fig. 14 - For N-Channel

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## TO-220-1



DIM.	MILLIN	METERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
Α	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
Е	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	

#### Note

 $\bullet$   $M^{\star}=0.052$  inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



Revison: 14-Dec-15 1 Document Number: 66542



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